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March 2001 Revised August 2003

74VCX32500

Low Voltage 36-Bit Universal Bus Transceivers with 3.6V Tolerant Inputs and Outputs

General Description

The VCX32500 is an 36-bit universal bus transceiver which combines D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

Data flow in <u>each</u> direction is controlled by output-enable (OEAB <u>and OEBA)</u>, <u>latch</u>-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the device operates in the transparent mode when <u>LEAB</u> is HIGH. When LEAB is LOW, the A data is latched if CLKAB is held at a HIGH or LOW logic level. If LEAB is LOW, the A bus data is <u>stored in</u> the latch/flip-flop on the HIGH-to-LOW transition of CLKAB. When OEAB is HIGH, the outputs are active. When OEAB is LOW, the outputs are in a high-impedance state.

<u>Data flow</u> for B to <u>A is similar</u> to that of A to B but uses <u>OEBA</u>, LEBA, and <u>CLKBA</u>. The output enables are complementary (OEAB is active HIGH and <u>OEBA</u> is active LOW)

The VCX32500 is designed for low voltage (1.4V to 3.6V) V_{CC} applications with I/O capability up to 3.6V.

The 74VCX32500 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

Features

- 1.4V to 3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- t_{PD} (A to B, B to A)
 2.9 ns max for 3.0V to 3.6V V_{CC}
- Power-down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- Static Drive (I_{OH}/I_{OL}) ±24 mA @ 3.0V V_{CC}
- Uses patented noise/EMI reduction circuitry
- Latchup performance exceeds 300 mA
- ESD performance:

Human body model > 2000V Machine model >200V

■ Packaged in plastic Fine-Pitch Ball Grid Array (FBGA)

Note 1: $\overline{\text{To}}$ ensure the high-impedance state during power up or power down, $\overline{\text{OEBA}}$ should be tied to V_{CC} through a pull-up resistor and OEAB should be tied to GND through a pull-down resistors; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

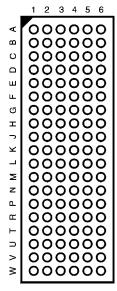
Ordering Code:

Order Number	Package Number	Package Description
74VCX32500G		114-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
(Note 2)(Note 3)	BGAT14A	114-ball Fille-Filch Ball Gild Altay (FBGA), JEDEC MO-200, 5.511111 Wide

Note 2: Ordering Code "G" indicates Trays.

Note 3: Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



(Top Thru View)

Pin Descriptions

Pin Names	Description
OEAB _n	Output Enable Input for A to B Direction (Active HIGH)
OEBA _n	Output Enable Input for B to A Direction (Active LOW)
LEAB _n , LEBA _n	Latch Enable Inputs
CLKAB _n , CLKBA _n	Clock Inputs
1A ₁ -1A ₁₈ 2A ₁ -2A ₁₈	Side A Inputs or 3-STATE Outputs
1B ₁ –1B ₁₈ 2B ₁ –2B ₁₈	Side B Inputs or 3-STATE Outputs

FBGA Pin Assignments

		1	2	3	4	5	6
1	1	1A ₂	1A ₁	LEAB ₁	CLKAB ₁	1B ₁	1B ₂
E	3	1A ₄	1A ₃	OEAB ₁	GND	1B ₃	1B ₄
(1A ₆	1A ₅	GND	GND	1B ₅	1B ₆
[)	1A ₈	1A ₇	V _{CC}	V _{CC}	1B ₇	1B ₈
E	•	1A ₁₀	1A ₉	GND	GND	1B ₉	1B ₁₀
F	=	1A ₁₂	1A ₁₁	GND	GND	1B ₁₁	1B ₁₂
	ć	1A ₁₄	1A ₁₃	V _{CC}	V _{CC}	1B ₁₃	1B ₁₄
H	+	1A ₁₅	1A ₁₆	GND	GND	1B ₁₆	1B ₁₅
,	J	1A ₁₇	1A ₁₈	OEBA ₁	CLKBA ₁	1B ₁₈	1B ₁₇
۲	(NC	LEAB ₂	LEBA ₁	GND	CLKAB ₂	NC
L	-	2A ₂	2A ₁	OEAB ₂	GND	2B ₁	2B ₂
N	Λ	2A ₄	2A ₃	GND	GND	2B ₃	2B ₄
ı	1	2A ₆	2A ₅	V _{CC}	V _{CC}	2B ₅	2B ₆
F	•	2A ₈	2A ₇	GND	GND	2B ₇	2B ₈
F	3	2A ₁₀	2A ₉	GND	GND	2B ₉	2B ₁₀
7	Γ	2A ₁₂	2A ₁₁	V _{CC}	V _{CC}	2B ₁₁	2B ₁₂
l	J	2A ₁₄	2A ₁₃	GND	GND	2B ₁₃	2B ₁₄
١	/	2A ₁₅	2A ₁₆	OEBA ₂	CLKBA ₂	2B ₁₆	2B ₁₅
٧	٧	2A ₁₇	2A ₁₈	LEBA ₂	GND	2B ₁₈	2B ₁₇

Function Table (Note 4)

	Inp	Outputs		
OEAB _n	LEAB _n	$\overline{\text{CLKAB}}_{\text{n}}$	$\mathbf{A}_{\mathbf{n}}$	B _n
L	Х	Х	Х	Z
Н	Н	X	L	L
Н	Н	X	Н	н
Н	L	\downarrow	L	L
Н	L	\downarrow	Н	н
Н	L	Н	Х	B ₀ (Note 5)
Н	L	L	Х	B ₀ (Note 6)

H = HIGH Voltage Level

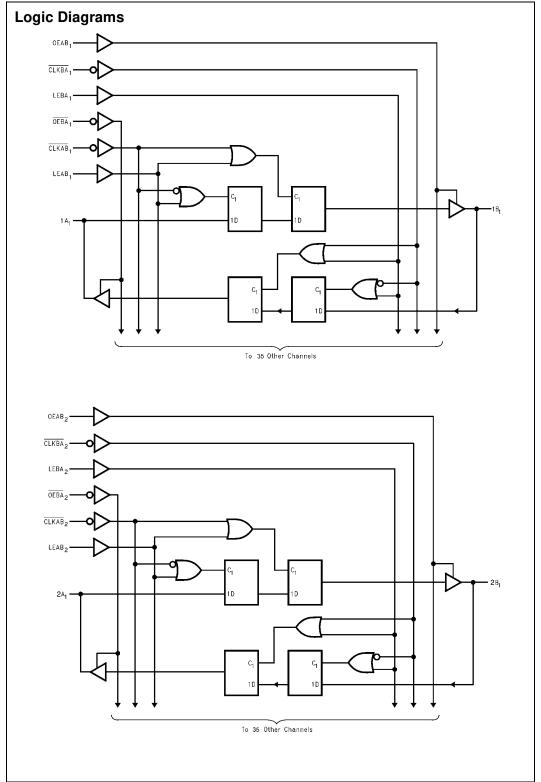
Note 4: A-to-B data flow is shown; B-to-A flow is similar but uses $\overline{\text{OEBA}}$, LEBA and $\overline{\text{CLKBA}}$. $\overline{\text{OEBA}}$ is active LOW.

Note 5: Output level before the indicated steady-state input conditions were established.

Note 6: Output level before the indicated steady-state input conditions were established, provided that $\overline{\text{CLKAB}}$ was LOW before LEAB went LOW.

L = LOW Voltage Level
X = Immaterial (HIGH or LOW, inputs may not float)

Z = High Impedance



Absolute Maximum Ratings(Note 7)

-0.5V to +4.6V Supply Voltage (V_{CC}) DC Input Voltage (V_I) -0.5V to +4.6V Output Voltage (V_O) Outputs 3-STATE -0.5V to +4.6VOutputs Active (Note 8) -0.5 to $V_{CC} + 0.5V$ -50 mA DC Input Diode Current (I_{IK}) $V_I < 0V$ DC Output Diode Current (I_{OK}) $V_O < 0V$ -50 mA $V_O > V_{CC}$ +50 mA

-65°C to +150°C

DC V_{CC} or Ground Current per Supply Pin (I_{CC} or GND) $\pm 100 \text{ mA}$

Storage Temperature Range (T_{STG})

Recommended Operating Conditions (Note 9)

 $\begin{tabular}{lll} Power Supply & & & & & & & \\ Operating & & & & & & & & \\ Input Voltage & & & & & & & & \\ Output Voltage & & & & & & & \\ Output Voltage & & & & & & \\ Output in Active States & & & & & \\ Output in Active States & & & & & \\ Output in 3-STATE & & & & & \\ Output Current in I_{OH}/I_{OL} & & & & \\ V_{CC} = 3.0V to 3.6V & & & & \\ V_{CC} = 2.3V to 2.7V & & & & \\ & & & & & \\ & & & & & \\ \hline \end{tabular}$

Minimum Input Edge Rate (Δt/ΔV)

 $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$ 10 ns/V

Note 7: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The Recommended Operating Conditions tables will define the conditions for actual device operation.

Note 8: IO Absolute Maximum Rating must be observed.

Note 9: Floating or unused pin (inputs or I/O's) must be held HIGH or LOW.

DC Electrical Characteristics

Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Units
V _{IH}	HIGH Level Input Voltage		2.7 - 3.6	2.0		
			2.3 - 2.7	1.6		V
			1.65 - 2.3	0.65 x V _{CC}		V
			1.4 - 1.6	0.65 x V _{CC}		
V _{IL}	LOW Level Input Voltage		2.7 - 3.6		0.8	
			2.3 - 2.7		0.7	V
			1.65 - 2.3		0.35 x V _{CC}	V
			1.4 - 1.6		0.35 x V _{CC}	
V _{OH}	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$	2.7 - 3.6	V _{CC} - 0.2		
		$I_{OH} = -12 \text{ mA}$	2.7	2.2		
		$I_{OH} = -18 \text{ mA}$	3.0	2.4		
		$I_{OH} = -24 \text{ mA}$	3.0	2.2		
		$I_{OH} = -100 \mu A$	2.3 - 2.7	V _{CC} - 0.2		
		$I_{OH} = -6 \text{ mA}$	2.3	2.0		V
		$I_{OH} = -12 \text{ mA}$	2.3	1.8		V
		$I_{OH} = -18 \text{ mA}$	2.3	1.7		
		$I_{OH} = -100 \mu A$	1.65 -2.3	V _{CC} - 0.2		
		$I_{OH} = -6 \text{ mA}$	1.65	1.25		
		$I_{OH} = -100 \mu A$	1.4 - 1.6	V _{CC} - 0.2		
		$I_{OH} = -2 \text{ mA}$	1.4	1.05		

DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Units
V _{OL}	LOW Level Output Voltage	I _{OL} = 100 μA	2.7 - 3.6		0.2	
		$I_{OL} = 12 \text{ mA}$	2.7		0.4	
		$I_{OL} = 18 \text{ mA}$	3.0		0.4	
		I _{OL} = 24 mA	3.0		0.55	
		$I_{OL} = 100 \ \mu A$	2.3 - 2.7		0.2	
		$I_{OL} = 12 \text{ mA}$	2.3		0.4	V
		$I_{OL} = 18 \text{ mA}$	2.3		0.6	
		$I_{OL} = 100 \ \mu A$	1.65 - 2.3		0.2	
		I _{OL} = 6 mA	1.65		0.3	
		$I_{OL} = 100 \ \mu A$	1.4 - 1.6		0.2	
		$I_{OL} = 2 \text{ mA}$	1.4		0.35	
II	Input Leakage Current	$0V \le V_1 \le 3.6V$	1.4 - 3.6		±5.0	μΑ
I _{OZ}	3-STATE Output Leakage	$0V \le V_O \le 3.6V$	1.4 - 3.6		±10.0	
		$V_I = V_{IH}$ or V_{IL}	1.4 - 3.6		±10.0	μΑ
I _{OFF}	Power Off Leakage Current	$0V \le (V_I, V_O) \le 3.6V$	0		10.0	μА
I _{CC}	Quiescent Supply Current	V _I = V _{CC} or GND	1.4 - 3.6		40.0	μА
		$V_{CC} \leq (V_I, \ V_O) \leq 3.6V \ (Note \ 10)$	1.4 - 3.6		±40.0	μΑ
ΔI_{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6V$	2.7 - 3.6		750	μΑ

Note 10: Outputs disabled or 3-STATE only.

AC Electrical Characteristics (Note 11)

Symbol	Paramoter	Parameter Conditions	V _{CC}	$T_A = -40^{\circ}C$ to $+85^{\circ}C$		Units	Figure
	Parameter	Conditions	(V)	Min	Max	Units	Number
f _{MAX}	Setup Time	C _L = 30 pF	3.3 ± 0.3	250			
			2.5 ± 0.2	200		MHz	
			1.8 ± 0.15 100		IVITIZ		
		C _L = 15 pF	1.5 ± 0.1	80.0			
t _{PHL}	Propagation Delay	$C_L = 30 \text{ pF}, R_L = 500\Omega$	3.3 ± 0.3	0.6	2.7		İ
t _{PLH}	Bus-to-Bus		2.5 ± 0.2	0.8	3.5		Figures 1
			1.8 ± 0.15	1.5	7.0	ns	
		$C_L = 15 \text{ pF}, R_L = 2k\Omega$	1.5 ± 0.1	1.0	14.0		Figures 7 8
t _{PHL}	Propagation Delay	$C_L = 30 \text{ pF}, R_L = 500\Omega$	3.3 ± 0.3	0.6	4.2		Ī
t _{PLH}	Clock-to-Bus		2.5 ± 0.2	0.8	5.3		Figures 1,
			1.8 ± 0.15	1.5	9.8	ns	_
		$C_L = 15 \text{ pF}, R_L = 500\Omega$	1.5 ± 0.1	1.0	19.6		Figures 7 8
t _{PHL}	Propagation Delay	$C_L = 30 \text{ pF}, R_L = 500\Omega$	3.3 ± 0.3	0.6	3.8		
t _{PLH}	LE-to-Bus		2.5 ± 0.2	0.8	4.9		Figures 1
			1.8 ± 0.15	1.5	9.8	ns	_
		$C_L = 15 \text{ pF}, R_L = 500\Omega$	1.5 ± 0.1	1.0	19.6		Figures 7 8
t _{PZL}	Output Enable Time	$C_L = 30 \text{ pF}, R_L = 500\Omega$	3.3 ± 0.3	0.6	3.8		Ī
t _{PZH}			2.5 ± 0.2	0.8	4.9		Figures 1 3, 4
			1.8 ± 0.15	1.5	9.8	ns	0, .
		$C_L = 15 \text{ pF}, R_L = 2k\Omega$	1.5 ± 0.1	1.0	19.6		Figures 7, 9, 10
t _{PLZ}	Output Disable Time	$C_L = 30 \text{ pF}, R_L = 500\Omega$	3.3 ± 0.3	0.6	3.7		
t _{PHZ}			2.5 ± 0.2	0.8	4.2		Figures 1 3, 4
			1.8 ± 0.15	± 0.15 1.5 7.	7.6	ns	3, 4
		$C_L = 15 \text{ pF}, R_L = 2k\Omega$	1.5 ± 0.1	1.0	15.2		Figures 7 9, 10

AC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V _{CC}	T _A = -40°	C to +85°C	Units	Figure
Cyllibol		Conditions	(V)	Min	Max	Oilles	Number
t _S	Setup Time	$C_L = 30 \text{ pF}, R_L = 500\Omega$	3.3 ± 0.3	1.5			
			2.5 ± 0.2	1.5			Figures 1,
			1.8 ± 0.15	2.5		ns	
		$C_L = 15 \text{ pF}, R_L = 500\Omega$	1.5 ± 0.1	3.0			Figures 7,
t _H	Hold Time	$C_L = 30 \text{ pF}, R_L = 500\Omega$	3.3 ± 0.3	1.0			
			2.5 ± 0.2	1.0			Figures 1,
			1.8 ± 0.15	1.0		ns	
		$C_L = 15 \text{ pF}, R_L = 500\Omega$	1.5 ± 0.1	2.0			Figures 7,
t _W	Pulse Width	$C_L = 30 \text{ pF}, R_L = 500\Omega$	3.3 ± 0.3	1.5			
			2.5 ± 1.2	1.5			Figures 1, 5
			1.8 ± 0.15	4.0		ns	
		$C_L = 15 \text{ pF}, R_L = 500\Omega$	1.5 ± 0.1	4.0			Figures 5,

Note 11: For $C_L = 50 pF$, add approximately 300ps to the AC maximum specification.

Dynamic Switching Characteristics

Symbol	Parameter	Conditions	V _{CC}	$T_A = +25^{\circ}C$	Units
	i arameter	Conditions	(V)	Typical	Onito
V _{OLP}	Quiet Output Dynamic	$C_L = 30 \text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	0.25	
	Peak V _{OL}		2.5	0.6	V
			3.3	0.8	
V _{OLV}	Quiet Output Dynamic	$C_L = 30 \text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	-0.25	
	Valley V _{OL}		2.5	-0.6	V
			3.3	-0.8	
V _{OHV}	Quiet Output Dynamic	$C_L = 30 \text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	1.5	
	Valley V _{OH}		2.5	1.9	V
			3.3	2.2	

Capacitance

Symbol	Parameter	Conditions	$\textbf{T}_{\boldsymbol{A}} = +25^{\circ}\textbf{C}$	Units
C _{IN}	Input Capacitance	$V_1 = 0V$ or V_{CC} $V_{CC} = 1.8V$, 2.5V, or 3.3V,	6.0	pF
C _{I/O}	Output Capacitance	$V_1 = 0V$, or V_{CC} , $V_{CC} = 1.8V$, 2.5V or 3.3V	7.0	pF
C _{PD}	Power Dissipation Capacitance	V _I = 0V or V _{CC} , f = 10 MHz V _{CC} = 1.8V, 2.5V or 3.3V	20.0	pF

AC Loading and Waveforms (V_{CC} 3.3V \pm 0.3V to 1.8V \pm 0.15V)

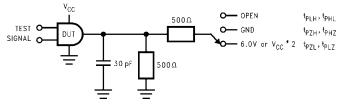


FIGURE 1. AC Test Circuit

TEST	SWITCH
t _{PLH} , t _{PHL}	Open
t _{PZL} , t _{PLZ}	6V at $V_{CC} = 3.3 \pm 0.3V$; $V_{CC} \times 2$ at $V_{CC} = 2.5 \pm 0.2V$; $1.8 \pm 0.15V$
t _{PZH} , t _{PHZ}	GND

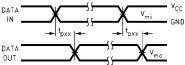
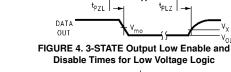


FIGURE 2. Waveform for Inverting and Non-inverting Functions



OUTPUT

CONTROL

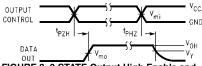


FIGURE 3. 3-STATE Output High Enable and Disable Times for Low Voltage Logic

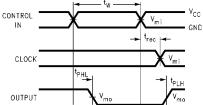


FIGURE 5. Propagation Delay, Pulse Width and $$t_{\rm rec}$$ Waveforms

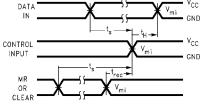
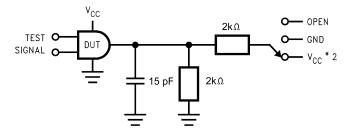


FIGURE 6. Setup Time, Hold Time and Recovery Time for Low Voltage Logic

Symbol		v _{cc}	
	$3.3V \pm 0.3V$	$2.5V \pm 0.2V$	1.8 ± 0.15V
V _{mi}	1.5V	V _{CC} /2	V _{CC} /2
V _{mo}	1.5V	V _{CC} /2	V _{CC} /2
V _X	$V_{OL} + 0.3V$	V _{OL} + 0.15V	V _{OL} + 0.15V
V _Y	V _{OH} – 0.3V	V _{OH} – 0.15V	V _{OH} – 0.15V

AC Loading and Waveforms (V $_{CC}$ 1.5V \pm 0.1V)



t_{PLH}, t_{PHL}
t_{PZH}, t_{PHZ}

TEST	SWITCH
t _{PLH} , t _{PHL}	Open
t _{PZL} , t _{PLZ}	V_{CC} x 2 at $V_{CC} = 1.5V \pm 0.1V$
t _{PZH} , t _{PHZ}	GND

FIGURE 7. AC Test Circuit

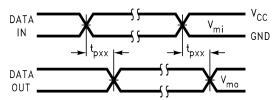


FIGURE 8. Waveform for Inverting and Non-Inverting Functions

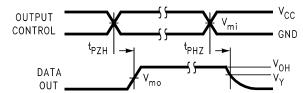


FIGURE 9. 3-STATE Output High Enable and Disable Times for Low Voltage Logic

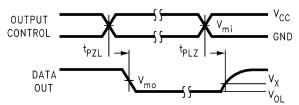


FIGURE 10. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic

Symbol	v _{cc}
	1.5V ± 0.1V
V _{mi}	V _{CC} /2
V _{mo}	V _{CC} /2
V _x	V _{OL} + 0.1V
V _y	V _{OH} – 0.1V

Physical Dimensions inches (millimeters) unless otherwise noted ○ 0.10 B 5.5 0.8 -(0.8)-(0.75) 0.10 A 000000 ABCDEFGHJĶLMNPRTUVW 16 14.4 PIN ONE 0.8 23456 114X0.5^{+0.05} Top **Bottom** View 0.15(M) C A B View 0.08(M) C // 0.15 C

NOTES:

A. THIS PACKAGE CONFORMS TO JEDEC M0-205 B. ALL DIMENSIONS IN MILLIMETERS

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- D. ALAND PATTERN RECOMMENDATION: NSMD (Non Solder Mask Defined)
 ...35MM DIA PADS WITH A SOLDERMASK OPENING OF .45MM CONCENTRIC TO PADS
 D. DRAWING CONFORMS TO ASME Y14.5M-1994

BGA114ArevE

1.4 MAX —

114-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide Package Number BGA114A

SEATING PLANE

O.10

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